TOSHIBA Field Effect Transistor Silicon P-Channel MOS Type

# SSM3J113TU

#### High Speed Switching Applications

- 2.0V drive
  - Low on-resistance:  $R_{on} = 449m\Omega (max) (@V_{GS} = -2.0 V)$

 $R_{on} = 249m\Omega \text{ (max)} (@V_{GS} = -2.5 \text{ V})$ 

 $R_{on} = 169m\Omega (max) (@V_{GS} = -4.0 V)$ 

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-Source voltage		V <sub>DS</sub>	-20	V	
Gate-Source voltage		V <sub>GSS</sub>	± 12	V	
Drain current	DC	I <sub>D</sub>	-1.7	А	
	Pulse	I <sub>DP</sub>	-3.4		
Drain power dissipation		PD (Note 1)	800	mW	
		PD (Note 2)	500		
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

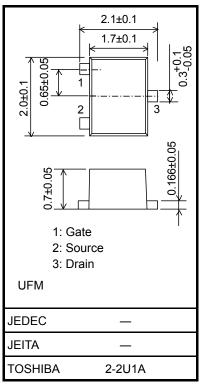
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on ceramic board. (25.4 mm  $\times$  25.4 mm  $\times$  0.8 mm, Cu Pad: 645 mm2 ) Note 2: Mounted on FR4 board.

(25.4 mm  $\times$  25.4 mm  $\times$  1.6 mm, Cu Pad: 645 mm2 )

#### **Electrical Characteristics (Ta = 25°C)**



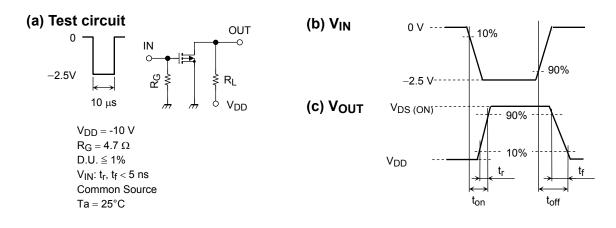
Weight: 6.6 mg (typ.)

Charact	eristic	Symbol	Test Conditions	Min	Тур.	Max	Unit
Drain-Source breakdown voltage		V (BR) DSS	$I_D = -1 \text{ mA}, V_{GS} = 0$	-20	_		v
		V (BR) DSX	$I_D = -1 \text{ mA},  V_{GS} = +12 \text{V}$	-8	—		
Drain cut-off curren	t	I <sub>DSS</sub>	$V_{DS}=-20~V,~V_{GS}=0$	_	_	-1	μA
Gate leakage curre	nt	I <sub>GSS</sub>	$V_{GS}=\pm 12V,\ V_{DS}=0$	_	_	±1	μA
Gate threshold volta	age	V <sub>th</sub>	$V_{DS} = -3 \text{ V}, \text{ I}_{D} = -0.1 \text{ mA}$	-0.5	_	-1.1	V
Forward transfer ac	Imittance	Y <sub>fs</sub>	$V_{DS} = -3 V, I_D = -0.65 A$ (Note3)	1.3	2.7	_	S
Drain-Source on-resistance		R <sub>DS</sub> (ON)	$I_D = -0.65 \text{ A}, V_{GS} = -4.0 \text{ V}$ (Note3)	_	129	169	mΩ
			$I_D = -0.65 \text{ A}, V_{GS} = -2.5 \text{ V}$ (Note3)		189	249	
			$I_D = -0.65 \text{ A}, V_{GS} = -2.0 \text{ V}$ (Note3)		249	449	
Input capacitance		C <sub>iss</sub>	$V_{DS} = -10 V, V_{GS} = 0, f = 1 MHz$	_	370	_	pF
Output capacitance		C <sub>oss</sub>	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0, \text{ f} = 1 \text{ MHz}$	_	116		pF
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0, \text{ f} = 1 \text{ MHz}$	_	73		pF
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD} = -10 \text{ V}, \text{ I}_{D} = -0.65 \text{ A},$	_	33		
	Turn-off time	t <sub>off</sub>	$V_{GS}$ = 0~–2.5 V, $R_{G}$ = 4.7 $\Omega$	_	47		ns
Drain-Source forward voltage		V <sub>DSF</sub>	$I_D = 1.7 \text{ A}, V_{GS} = 0 \text{ V}$ (Note3)	_	0.77	1.2	V

Note3: Pulse test

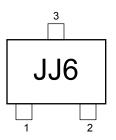
Unit: mm

## Switching Time Test Circuit



#### Marking

#### Equivalent Circuit (top view)



### Precaution

 $V_{th}$  can be expressed as the voltage between gate and source when the low operating current value is  $I_D$ =–0.1mA for this product. For normal switching operation,  $V_{GS\ (on)}$  requires a higher voltage than  $V_{th,}$  and  $V_{GS\ (off)}$  requires a lower voltage than  $V_{th.}$ 

(The relationship can be established as follows:  $V_{GS (off)} < V_{th} < V_{GS (on)}$ )

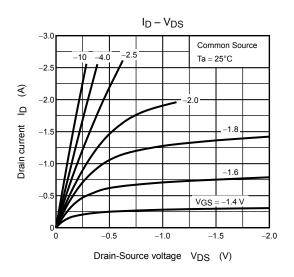
Take this into consideration when using the device.

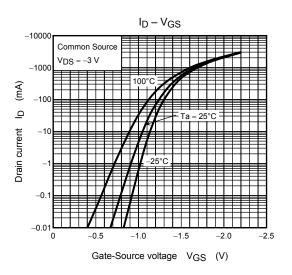
### **Handling Precaution**

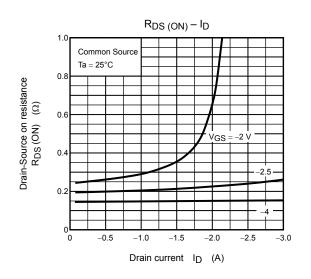
When handling individual devices which are not yet mounted on a circuit board, be sure that the environment is protected against electrostatic discharge. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

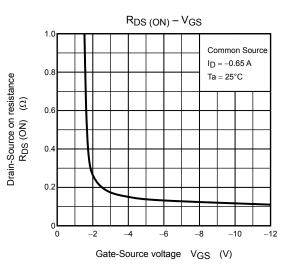
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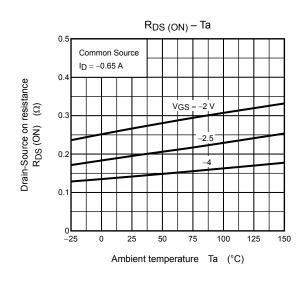


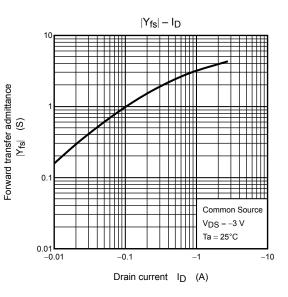




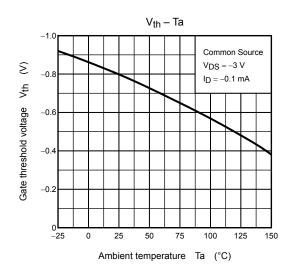


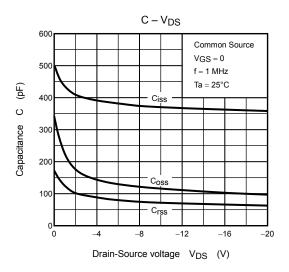


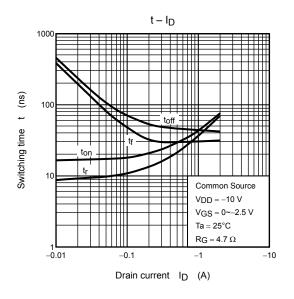


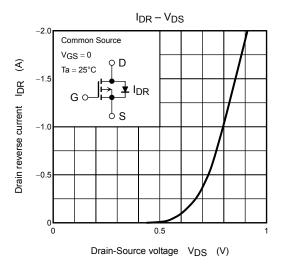


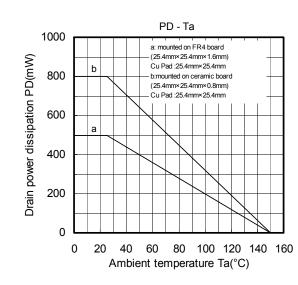
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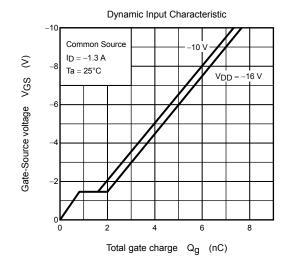




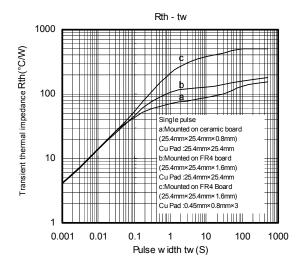








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20070701-EN GENERAL

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